

IN THE CLAIMS:

Kindly cancel claims 13-17 without prejudice or disclaimer. A detailed listing of all claims is as follows.

Claim 1 (Previously Presented): A method of fabricating a liquid crystal display panel having first and second substrates, the method comprising the steps of:

forming a first and second orientation films on the first and second substrates, respectively;

forming a seal material at edges of the first substrate;

assembling the first and second substrates with each other;

performing a first pressurizing and heating process on the first and second substrates to form a first cell gap;

injecting a liquid crystal material into the first cell gap;

performing a second pressurizing and heating process on the first and second substrates to form a second cell gap, wherein the second heating process is sufficient to soften the seal material, the second pressurizing and heating process applies a greater pressure and a higher temperature to the first and second substrates than the first pressurizing and heating process, and the second cell gap is narrower than the first cell gap; and

sealing the second cell gap.

Claim 2 (Original): The method according to claim 1, further comprising the step of sealing the first cell gap before the step of performing the second pressurizing and heating process.

Claim 3 (Cancelled).

Claim 4 (Original): The method according to claim 1, wherein the first cell gap is at least 5 μm .

Claim 5 (Original): The method according to claim 1, wherein the second cell gap is at least 4 μm .

Claim 6 (Original): The method according to claim 1, wherein the step of sealing is performed by using a thermoplastic resin.

Claim 7 (Previously Presented): A method of fabricating a liquid crystal display panel having first and second substrates, the method comprising the steps of:

assembling the first substrate with the second substrate;

performing a first pressurizing and heating process on the assembled substrates to have a first cell gap;

injecting a liquid crystal material into the first cell gap;

performing a second pressurizing and heating process on the substrates to have a second cell gap, wherein the second heating process is sufficient to soften the seal material, the second pressurizing and heating process applies a greater pressure and a higher temperature to the first and second substrates than the first pressurizing and heating process, and the second cell gap is narrower than the first cell gap;

sealing the second cell gap; and
cutting the sealed panel into a unit cell.

Claim 8 (Original): The method according to claim 7, further comprising the step of sealing the first cell gap before the step of performing the second pressurizing and heating process.

Claim 9 (Cancelled).

Claim 10 (Original): The method according claim 7, wherein the first cell gap is at least 5 μm .

Claim 11 (Original): The method according to claim 7, wherein the second cell gap is at least 4 μm .

Claim 12 (Original): The method according to claim 1, wherein the step of sealing is performed by using a thermoplastic resin.

Claims 13-17 (Canceled).